BT134W series

GENERAL DESCRIPTION

Glass passivated triacs in a plastic envelope suitable for surface mounting, intended for use in applications requiring high bidirectional transient and blocking voltage capability and high thermal cycling performance. Typical applications include motor control, industrial and domestic lighting, heating and static switching.

PINNING - SOT223

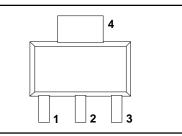
QUICK REFERENCE DATA

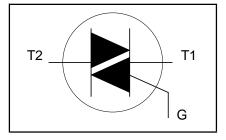
SYMBOL	PARAMETER	MAX.	MAX.	MAX.	UNIT
	BT134W- BT134W- BT134W-	500 500F 500G	600 600F 600G	800 800F 800G	
V _{DRM}	Repetitive peak off-state	500	600	800	V
I _{T(RMS)} I _{TSM}	voltages RMS on-state current Non-repetitive peak on-state current	1 10	1 10	1 10	A A

PIN CONFIGURATION

SYMBOL

PIN	IN DESCRIPTION		
1	main terminal 1		
2	main terminal 2		
3	gate		
tab	main terminal 2		





LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.		MAX.		UNIT
V _{drm}	Repetitive peak off-state voltages		-	-500 500 ¹	-600 600 ¹	-800 800	V
I _{T(RMS)} I _{TSM}	RMS on-state current Non-repetitive peak on-state current	full sine wave; $T_{sp} \le 108$ °C full sine wave; $T_j = 25$ °C prior to surge	-		1		A
		t = 20 ms	-		10		A
l ² t	I ² t for fusing	t = 16.7 ms t = 10 ms	-		11 0.5		A A ² s
dl _⊤ /dt	Repetitive rate of rise of on-state current after	$I_{TM} = 1.5 \text{ A}; I_G = 0.2 \text{ A};$ $dI_G/dt = 0.2 \text{ A}/\mu\text{s}$	-		0.5		AS
	triggering	T2+ G+	-		50		A/μs
		T2+G-	-		50		A/µs
		T2- G- T2- G+	-		50 10		A/μs A/μs
I _{GM}	Peak gate current	12- 6+	_				Α Α
VGM	Peak gate voltage		-		2 5 5		V V
P _{GM}	Peak gate power		-				W
$\begin{array}{c} P_{G(AV)}^{O(M)} \\ T_{stg}^{stg} \\ T_{j} \end{array}$	Average gate power Storage temperature Operating junction temperature	over any 20 ms period	- -40 -		0.5 150 125		ວໍວໍ&

¹ Although not recommended, off-state voltages up to 800V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 3 $A/\mu s$.

BT134W series

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R _{th j-sp}	Thermal resistance junction to solder point	full or half cycle	-	-	15	K/W
R _{th j-a}	Thermal resistance junction to ambient	pcb mounted; minimum footprint pcb mounted; pad area as in fig:14	-	156 70	-	K/W K/W

STATIC CHARACTERISTICS

 $T_j = 25$ °C unless otherwise stated

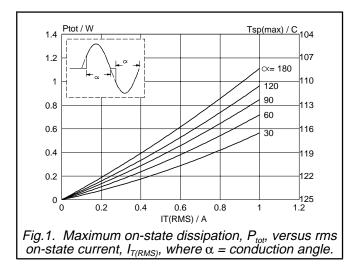
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.		MAX.		UNIT
I _{GT}	Gate trigger current	BT134W - $V_{\rm D} = 12 \text{ V}; I_{\rm T} = 0.1 \text{ A}$				F	G	
·GI		T2+G+ T2+G-	-	5 8	35 35	25 25	50 50	mA mA
		T2- G- T2- G+	-	11 30	35 70	25 70	50 100	mA mA
IL.	Latching current	$V_{\rm D} = 12 \text{ V}; \text{ I}_{\rm GT} = 0.1 \text{ A}$ T2+ G+	-	7	20	20	30	mA
		T2+ G- T2- G- T2- G+	-	16 5 7	30 20 30	30 20 30	45 30 45	mA mA mA
I _H	Holding current	$V_{\rm D} = 12 \text{ V}; \text{ I}_{\rm GT} = 0.1 \text{ A}$	-	5	15	15	30	mA
$V_{T} V_{GT}$	On-state voltage Gate trigger voltage	$I_T = 2 A$ $V_D = 12 V; I_T = 0.1 A$ $V_D = 400 V; I_T = 0.1 A;$	- - 0.25	1.2 0.7 0.4		1.50 1.5 -		V V V
I _D	Off-state leakage current	$T_{j} = 125 °C$ $V_{D} = V_{DRM(max)}$; $T_{j} = 125 °C$	-	0.1		0.5		mA

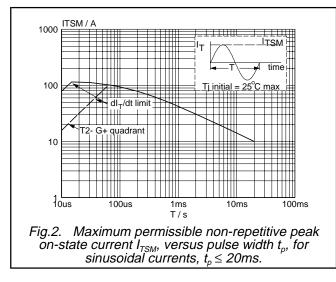
DYNAMIC CHARACTERISTICS

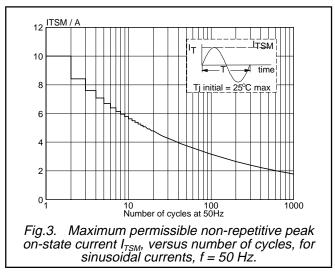
 $T_i = 25$ °C unless otherwise stated

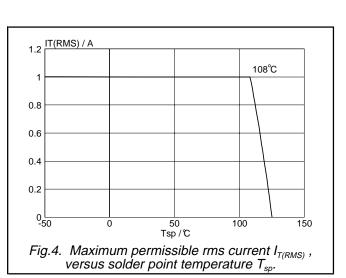
SYMBOL	PARAMETER	CONDITIONS		MIN.		TYP.	MAX.	UNIT
dV _D /dt	Critical rate of rise of off-state voltage	BT134W- $V_{DM} = 67\% V_{DRM(max)};$ $T_j = 125 °C; exponentialwaveform; gate open$	 100	F 50	G 200	250	-	V/µs
dV _{com} /dt	Critical rate of change of commutating voltage	circuit $V_{DM} = 400 \text{ V}; \text{ T}_{j} = 95 \text{ °C};$ $I_{T(RMS)} = 1 \text{ A};$ $dI_{com}/dt = 1.8 \text{ A/ms}; \text{ gate}$	-	-	10	50	-	V/µs
t _{gt}	Gate controlled turn-on time	open circuit $I_{TM} = 1.5 \text{ A};$ $V_D = V_{DRM(max)}; I_G = 0.1 \text{ A};$ $dI_G/dt = 5 \text{ A}/\mu s;$	-	-	-	2	-	μs

BT134W series









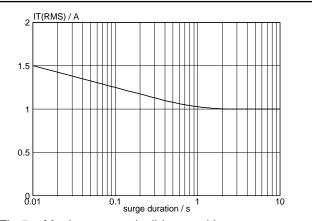
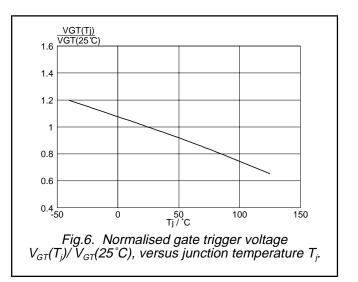
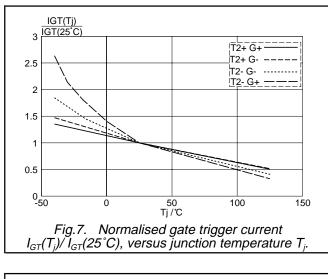


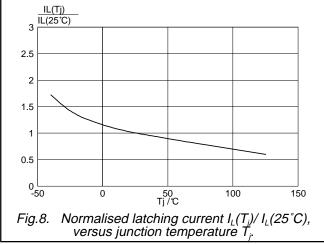
Fig.5. Maximum permissible repetitive rms on-state current $I_{T(RMS)}$, versus surge duration, for sinusoidal currents, f = 50 Hz; $T_{sp} \le 108$ °C.

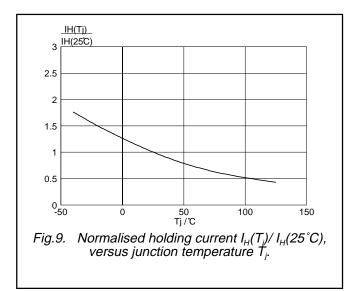


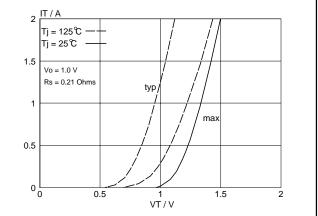
Downloaded from Elcodis.com electronic components distributor

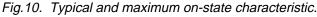
BT134W series

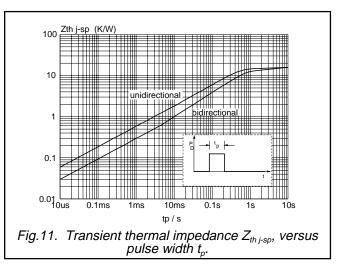


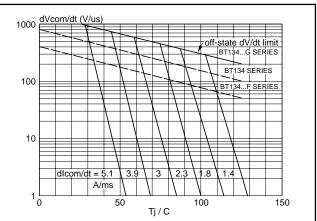


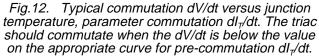










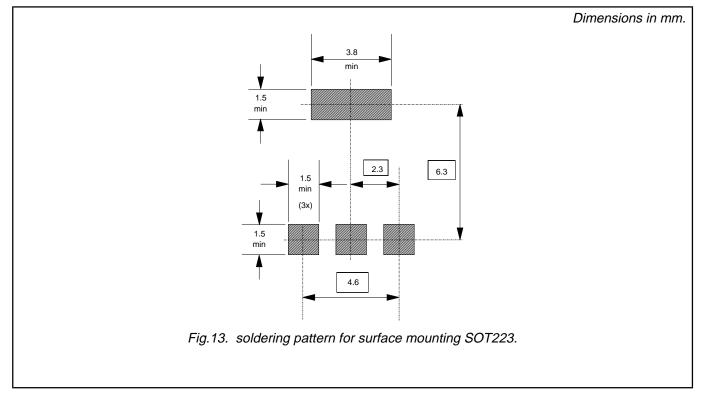


Downloaded from Elcodis.com electronic components distributor

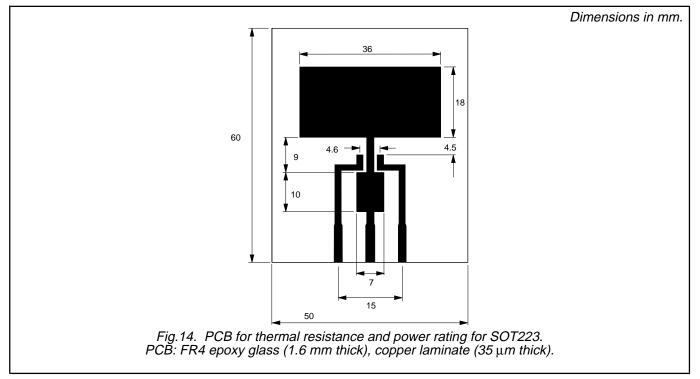
Product specification

BT134W series

MOUNTING INSTRUCTIONS



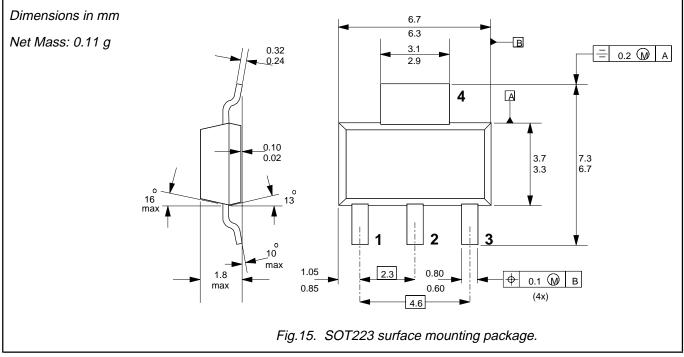
PRINTED CIRCUIT BOARD



Product specification

BT134W series

MECHANICAL DATA



Notes

For further information, refer to Philips publication SC18 " SMD Footprint Design and Soldering Guidelines". Order code: 9397 750 00505.
Epoxy meets UL94 V0 at 1/8".

BT134W series

DEFINITIONS

Data sheet status					
Objective specification	bjective specification This data sheet contains target or goal specifications for product development.				
Preliminary specification	pecification This data sheet contains preliminary data; supplementary data may be published later.				
Product specification	This data sheet contains final product specifications.				
Limiting values					
or more of the limiting val operation of the device at	in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one ues may cause permanent damage to the device. These are stress ratings only and these or at any other conditions above those given in the Characteristics sections of aplied. Exposure to limiting values for extended periods may affect device reliability.				
Application information					
Where application information is given, it is advisory and does not form part of the specification.					
© Philips Electronics N.V. 1997					
All rights are reserved. R copyright owner.	All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.				

The information presented in this document does not form part of any quotation or contract, it is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent or other industrial or intellectual property rights.

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.